ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo opyright 2005. IPC, Bannoc onternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	level	parts, the	declaration	encomp	asses all lo	wer level mat	erials for whic	f the item is an assembly the manufacturer has is declaration.			
1752-2 1.1 IPC Web Site for Information on IPC http://www.ipc.org/IPC-175x				-1752 Standard			m Type * ribute		Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat							
Supplier Information																
Company Name *		Company Unique ID		Unique ID Authority			Response Date *			esponse Do	cument ID					
SEMTECH CORPORATI						2010-04-30										
Contact Name *		Title - Contact		Phone - Contact *			Email - Contact *			D l'	t- Ott	A !	Dannasantatina			
HILMY SOEDJADI				(805) 498-2111			hsoedjadi@semtech.com			Duplica	te Contact	-> Authorized	Representative			
Authorized Representat	ive *	Title - Representative	Э	Phone - Representative *			Email - Representative *			upplier Com	ments or UR	L for Additiona	al Information			
HILMY SOEDJADI				(805) 498-21	11	hsoe	djadi@ser	mtech.co	m							
Requester Item Number	er	Mfr Item Number		Mfr Item Name			Effective Date Ve		Manufac	uring Site	Weight *	UOM	Unit Type			
		RClamp0524PATCT		Ultra Low Capacitance TVS Arra China					3.9864	mg	Each					
Alternate Recommend	lation						Alterr		ate Item Comments		•	•				
Manufacturing Proce	ss In	formation														
Terminal Plating / Grid Array Material Terr			Terminal B	ase Alloy	J-STD-020 MSL Ra	iting	Peak Proc	ak Process Body Temp		ure Max Tim	ne at Peak Tem	perature Numb	per of Reflow Cycles			
Nickel/Palladium/Gold	d/Au)	CU Alloy	,	1			260			30 seconds 3						
Comments																

Save the fields in Import fields from a Clear all of the Lock the fields on this **Export Data** Import Data Reset Form Lock Supplier Fields this form to a file file into this form fields on this form form to prevent changes **RoHS Material Composition Declaration Declaration Type \*** Detailed Rohs Directive Rohs Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenvls (PBB). Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium 2002/95/EC Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply. 1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance \* Accepted **RoHS Declaration \*** Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. **Declaration Signature** 

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## **Homogeneous Material Composition Declaration for Electronic Products**

**Subltem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	- 1	Item/SubItem			Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of	Tolerance		PPM
		Name			Material	Weight	Measure			Levei	Substance Category			Substance	CAS	Lxempt	weight	Measure	-	+	
+1 -	·I (	Chip	+M	-M	Silicon Die	0.0403	mg	+C	-C	Supplier		+S	-S	Silicon (Si)	7440-21-3		0.0403	mg			
+1 -	·I	Lead Frame	+M	-M	C7025	1.3587	mg	+C	-C	Supplier		+S	-S	Copper (Cu)	7440-50-8		1.303	mg			
												+S	-S	Silicon (Si)	7440-21-3		0.0099	mg			
												+S	Ģ	Magnesium (Mg)	7439-95-4		0.0024	mg			
								+C	-C	В	Nickel (external applic	+S	-S	Nickel	7440-02-0		0.0435	mg			
+1 -	·I	Lead Finish ·	+M	-M	Ni/Pd/Au plating	0.0349	mg	+C	-C	В	Nickel (external applic	+S	-S	Nickel	7440-02-0		0.0314	mg			
								+C	-C	Supplier		+S	-S	Palladium (Pd)	7440-05-3		0.0029	mg			
												+S	-S	Gold (Au)	7440-57-5		0.0006	mg			
+1 -	·I	Bonding Wire	+M	-M	Gold Wire	0.0422	mg	+C	-C	Supplier		+S	-S	Gold (Au)	7440-57-5		0.0422	mg			
+1 -	·	Molding Compound	+M	-M	EME-G770H CD	2.4726	mg	+C	-C	Supplier		+S	-S	Silica Fused	60676-86-0		2.3119	mg			
	_	_										+S	-S	Epoxy Resin	Proprietary		0.0742	mg			
												+S	-S	Phenol Resin	Proprietary		0.0742	mg			
									_			+S	Ģ	Carbon Black	1333-86-4		0.0124	mg			
+1 -	·I	Die Attached Epoxy	+M	-M	QMI519	0.0382	mg	+C	-C	Supplier		+S	-S	Silver (Ag)	7440-22-4		0.0306	mg			
												+S	Ģ	Palladium Compound	Proprietary		0.000057	mg			
												+S	-S	2,6-di-tert-butyl-p-creso	128-37-0		0.000001	mg			
												+S	-S	Hydroquinone	123-31-9		0.000000	mg			
												+S	-S	Acrylate	Proprietary		0.0061	mg			
												+S	-S	Bismaleimide Resin	Proprieatry		0.0011	mg			
												+S	-s	Polymer of Polybutadie	Proprietary		0.0004	mg			